## 1. General description

TThe 74ALVCH16543 is a 16-bit registered transceiver with bus hold inputs and 3-state outputs. The device can be used as two 8-bit transceivers or one 16-bit transceiver.

Data flow in each direction is controlled by intput enable (nEAB and nEBA), latch enable (nEAB and nEBA), and output enable (nOEAB and nOEBA) inputs. For A to B data flow, the device operates in the transparen mode when (nEAB) and (nLEAB) are LOW. A subsequent LOW-to-HIGH transition of the nLEAB input latches the data and the outputs no longer change with the inputs. A HIGH on either nEAB or nOEAB causes the outputs to assume a high-impedance OFF-state.

Control of data flow from B to A is similar, but using the  $n\overline{EBA}$ ,  $n\overline{LEBA}$ , and  $n\overline{OEBA}$  inputs. This device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

## 2. Features and benefits

- Wide supply voltage range from 1.65 V to 3.6 V
- · CMOS low power dissipation
- · Direct interface with TTL levels
- MULTIBYTE<sup>™</sup> flow-through standard pin-out architecture
- · Back-to-back registers for storage
- Output drive capability 50 Ω transmission lines at 85 °C
- All data inputs have bushold
- Low inductance multiple V<sub>CC</sub> and GND pins for minimize noise and ground bounce
- Current drive ±24 mA at V<sub>CC</sub> = 3.0 V.
- 3-state non-inverting outputs for bus oriented applications
- Complies with JEDEC standards:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

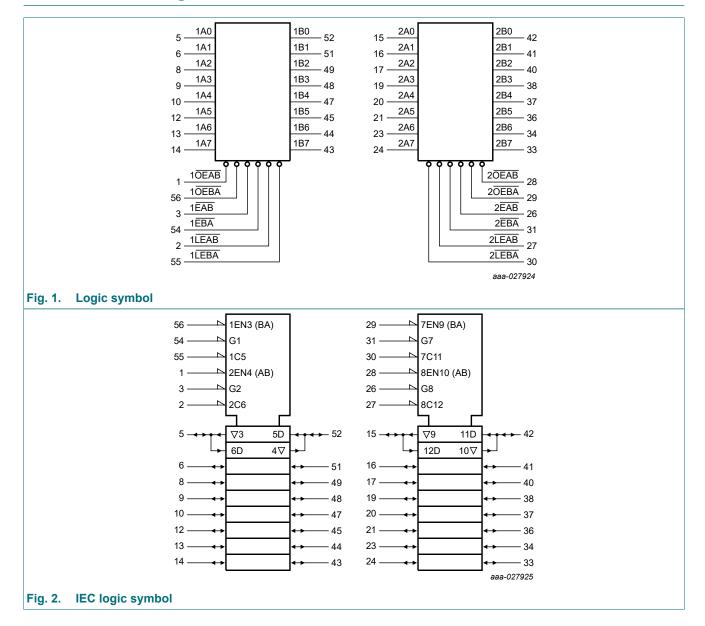
# 3. Ordering information

#### **Table 1. Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74ALVCH16543DGG	-40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1

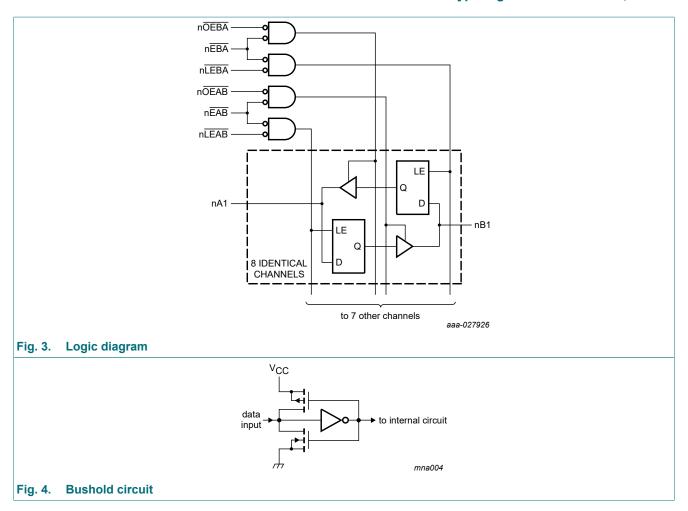


# 4. Functional diagram



Nexperia 74ALVCH16543

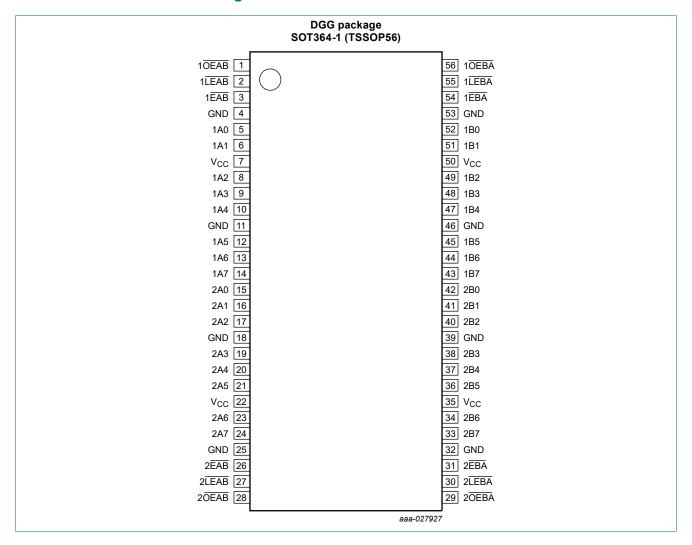
## 16-bit D-type registered transceiver; 3-state



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# 5. Pinning information

## 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	5, 6, 8, 9, 10, 12, 13, 14	data inputs/outputs
2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	15, 16, 17, 19, 20, 21, 23, 24	data inputs/outputs
1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	52, 51, 49, 48, 47, 45, 44, 43	data inputs/outputs
2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	42, 41, 40, 38, 37, 36, 34, 33	data inputs/outputs
1OEAB, 2OEAB	1, 28	A to B output enable inputs (active LOW)
1 <del>OEBA</del> , 2 <del>OEBA</del>	56, 29	B to A output enable inputs (active LOW)
1EAB, 2EAB	3, 26	A to B enable inputs (active LOW)
1EBA, 2EBA	54, 31	B to A enable inputs (active LOW)
1LEAB, 2LEAB	2, 27	A to B latch enable inputs (active LOW)
1LEBA, 2LEBA	55, 30	B to A latch enable inputs (active LOW)
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
Vcc	7, 22, 35, 50	supply voltage

# 6. Functional description

#### **Table 3. Function selection**

H = HIGH voltage level;

 $h = HIGH \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ LOW-to-HIGH \ transition \ of \ n\overline{LEAB}, \ n\overline{LEBA}, \ n\overline{EAB} \ or \ n\overline{EBA};$ 

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH transition of  $n\overline{LEAB}$ ,  $n\overline{LEBA}$ ,  $n\overline{EAB}$  or  $n\overline{EBA}$ ;

 $\uparrow$  = LOW-to-HIGH transition of  $n\overline{LEAB}$ ,  $n\overline{LEBA}$ ,  $n\overline{EAB}$  or  $n\overline{EBA}$ ;

NC = no change; X = don't care; Z = high-impedance OFF-state.

Inputs				Outputs	Status
nOEAB or nOEBA	nEAB or nEBA	nLEAB or nLEBA	nAn or nBn	nBn or nAn	
Н	Х	Х	X	Z	disabled
Χ	Н	X	X	Z	disabled
L	1	L	h	Z	disabled + latch
L	1	L	I	Z	disabled + latch
L	L	1	h	Н	latch + display
L	L	1	I	L	latch + display
L	L	L	Н	Н	transparent
L	L	L	L	L	transparent
L	L	Н	X	NC	hold

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# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+4.6	V
Vo	output voltage	[1]	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
I <sub>O</sub>	output current	$V_O = 0 \text{ V to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +85 °C	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	maximum speed performance				
		C <sub>L</sub> = 30 pF	2.3	2.5	2.7	V
		C <sub>L</sub> = 50 pF	3.0	3.3	3.6	V
		low-voltage applications	1.2	2.4	3.6	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.3 V to 3.0 V	-	-	20	ns/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	10	ns/V

## 9. Static characteristics

**Table 6. Static characteristics** 

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-4	0 to +85 °C		Unit
			Min	Typ[1]	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	1.2	-	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	1.5	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.3 V to 2.7 V	-	1.2	0.7	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	-	1.5	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$				
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V
		$I_O = -6 \text{ mA}; V_{CC} = 2.3 \text{ V}$	V <sub>CC</sub> - 0.3	V <sub>CC</sub> - 0.08	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.26	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.14	-	V
	$I_O = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.09	-	V	
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	V <sub>CC</sub> - 1.0	V <sub>CC</sub> - 0.28	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
output vo	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	-	GND	0.20	V
		$I_{O}$ = 6 mA; $V_{CC}$ = 2.3 V	-	0.07	0.40	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.3 V	-	0.15	0.70	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	0.14	0.40	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	0.27	0.55	V
l <sub>l</sub>	input leakage current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND	-	0.1	5	μA
I <sub>OZ</sub>	OFF-state output current	$V_{CC}$ = 2.3 V to 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $V_O$ = $V_{CC}$ or GND	/ <sub>IL</sub> ;		10	μA
I <sub>CC</sub>	supply current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A	-	0.2	40	μA
Δl <sub>CC</sub>	additional supply current	per data I/O pin; V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	150	750	μA
I <sub>BHL</sub>	bus hold LOW	$V_{CC} = 2.3 \text{ V}; V_I = 0.7 \text{ V}$	45	-	-	μΑ
	current	$V_{CC} = 3.0 \text{ V}; V_I = 0.8 \text{ V}$	75	150	-	μΑ
I <sub>BHH</sub>	bus hold HIGH	$V_{CC} = 2.3 \text{ V}; V_I = 1.7 \text{ V}$	-45	-	-	μΑ
	current	$V_{CC} = 3.0 \text{ V}; V_I = 2.0 \text{ V}$	-75	-175	-	μΑ
I <sub>BHLO</sub>	bus hold LOW overdrive current	V <sub>CC</sub> = 3.6 V	500 -		-	μΑ
I <sub>BHHO</sub>	bus hold HIGH overdrive current	V <sub>CC</sub> = 3.6 V	-500	-	-	μA
C <sub>I</sub>	input capacitance		-	4.0	-	pF

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

**Table 7. Dynamic characteristics** 

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 9.

Symbol	Parameter	Conditions	-	40 to +85 °	,C	Unit
			Min	Typ[1]	Max	
t <sub>pd</sub>	propagation	nAn to nBn; nBn to nAn; see Fig. 5 [2]				
	delay	V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.4	5.1	ns
		V <sub>CC</sub> = 2.7 V	-	2.9	4.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.8	4.3	ns
		nLEAB to nBn; nLEBA to nAn; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.3	6.5	ns
		V <sub>CC</sub> = 2.7 V	-	3.6	6.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	3.1	5.0	ns
t <sub>en</sub>	enable time	nOEBA to nAn; nOEAB to nBn; see Fig. 7 [3]				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.3	6.8	ns
		V <sub>CC</sub> = 2.7 V	-	3.4	6.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.9	5.3	ns
		nEBA to nAn; nEAB to nBn; see Fig. 7				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.3	7.2	ns
		V <sub>CC</sub> = 2.7 V	-	3.5	6.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.0	5.6	ns
t <sub>dis</sub>	disable time	nOEBA to nAn; nOEAB to nBn; see Fig. 7 [4]				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.9	5.7	ns
		V <sub>CC</sub> = 2.7 V	-	3.3	4.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.2	4.6	ns
		nEBA to nAn; nEAB to nBn; see Fig. 7				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.3	3.3	6.1	ns
		V <sub>CC</sub> = 2.7 V	-	3.5	6.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	3.3	5.1	ns
t <sub>W</sub>	pulse width	nLEAB, nLEBA LOW; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.3	1.2	-	ns
		V <sub>CC</sub> = 2.7 V	3.3	1.3	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.3	0.9	-	ns
t <sub>su</sub>	set-up time	nAn to nEAB; nBn to nEBA; nAn to nEAB; nBn to nEBA; see Fig. 8				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.2	0.2	-	ns
		V <sub>CC</sub> = 2.7 V	0.8	0.2	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	0.1	-	ns
t <sub>h</sub>	hold time	nAn to nLEAB; nBn to nLEBA; nAn to nEAB; nBn to nEBA; see Fig. 8				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.2	0.2	-	ns
		V <sub>CC</sub> = 2.7 V	0.4	0.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.7	0.2	_	ns

Symbol	Parameter	Conditions	-4	-40 to +85 °C			
			Min	Typ[1]	Max		
C <sub>PD</sub>	power	per latch; $V_I = GND$ to $V_{CC}$ [5]					
dissipation capacitance		outputs enabled	-	44	-	pF	
Сараска	capacitarioc	outputs disabled	-	14	-	pF	

- [1] Typical values are measured at T<sub>amb</sub> = 25 °C
  - Typical values for  $V_{CC}$  = 2.3 V to 2.7 V are measured at  $V_{CC}$  = 2.5 V.
  - Typical values for  $V_{CC}$  = 3.0 V to 3.6 V are measured at  $V_{CC}$  = 3.3 V.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3]  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .
- [4]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

f<sub>i</sub> = input frequency in MHz;

 $f_o$  = output frequency in MHz;

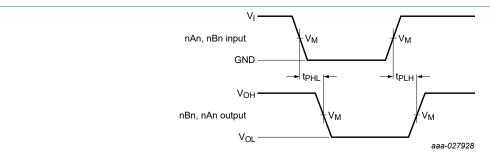
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = total load switching outputs;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

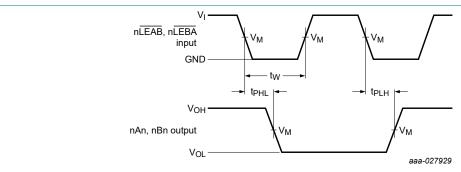
### 10.1. Waveforms and test circuit



See Table 8 for measurement points.

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 5. Input (nAn, nBn) to output (nBn, nAn) propagation delays



See Table 8 for measurement points.

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 6. Input (nLEAB, nLEBA) to output (nBn, nAn) propagation delays and (nLEAB, nLEBA) pulse width

Product data sheet

Nexperia 74ALVCH16543

## 16-bit D-type registered transceiver; 3-state

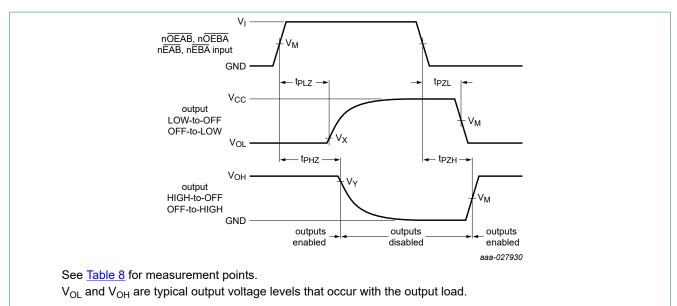
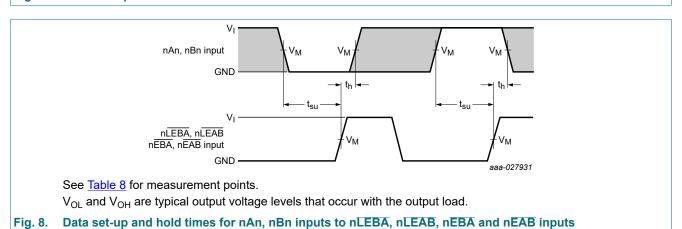


Fig. 7. 3-state output enable and disable times

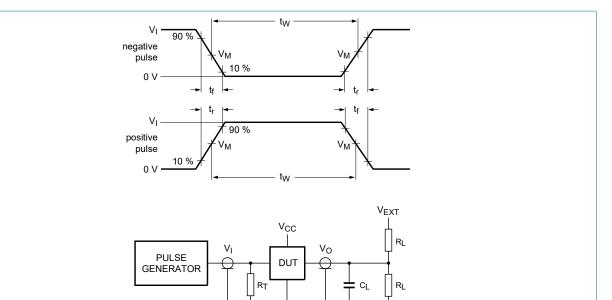


**Table 8. Measurement points** 

Input	-		Output	Output			
V <sub>CC</sub>	V <sub>I</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>x</sub>	V <sub>y</sub>		
2.3 V to 2.7 V	V <sub>CC</sub>	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V		
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		

Nexperia 74ALVCH16543

## 16-bit D-type registered transceiver; 3-state



001aae235

Test data is given in Table 9.

Definitions test circuit:

R<sub>L</sub> = Load resistance;

C<sub>L</sub> = Load capacitance including jig and probe capacitance;

 $R_{T}$  = Termination resistance should be equal to output impedance  $Z_{o}$  of the pulse generator;

 $V_{EXT}$  = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

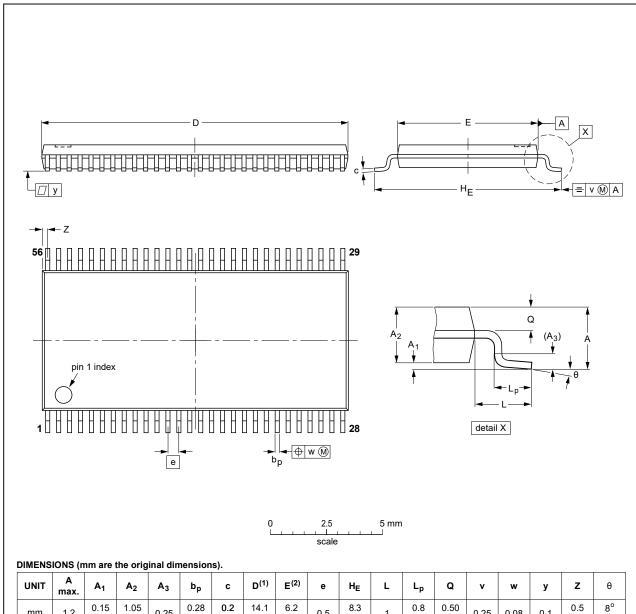
Table 9. Test data

Input	Load		V <sub>EXT</sub>				
$V_{CC}$ $V_{I}$ $t_r, t_f$		t <sub>r</sub> , t <sub>f</sub>	$R_L$	CL	t <sub>PHZ</sub> , t <sub>PZH</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	500 Ω	30 pF	GND	2 × V <sub>CC</sub>	open
2.7 V	2.7 V	≤ 2.5 ns	500 Ω	50 pF	GND	2 × V <sub>CC</sub>	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	500 Ω	50 pF	GND	2 × V <sub>CC</sub>	open

# 11. Package outline

### TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT364-1		MO-153			<del>99-12-27</del> 03-02-19

Fig. 10. Package outline SOT364-1 (TSSOP56)

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

# 13. Revision history

### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ALVCH16543 v.4	20240703	Product data sheet	-	74ALVCH16543 v.3	
Modifications:	<ul> <li>Section 1 updated.</li> <li>Section 2 updated, including ESD specifications.</li> <li>Table 4: P<sub>tot</sub> total power dissipation updated.</li> </ul>				
74ALVCH16543 v.3	20171215	Product data sheet	-	74ALVCH16543 v.2	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
74ALVCH16543 v.2	19991123	Product specification	-	74ALVCH16543 v.1	
74ALVCH16543 v.1	19980831	Product specification	-	-	

## 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

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